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APPLICATION NO.		FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/621,844		07/16/2003	Janet Patterson	73537 (1328)	1787
24272	7590	02/07/2005		EXAMINER	
Gregory J.	Koerner		NGUYEN, DONGHAI D		
Redwood Pa	atent Law			•	
1291 East Hillsdale Boulevard				ART UNIT	PAPER NUMBER
Suite 205				3729	
Foster City, CA 94404				DATE MAILED: 02/07/2005	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)					
Office Action Comment	10/621,844	PATTERSON, JANET					
Office Action Summary	Examiner	Art Unit					
	Donghai D. Nguyen	3729					
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the c	orrespondence address					
A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a repl If NO period for reply is specified above, the maximum statutory period - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be time y within the statutory minimum of thirty (30) days will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDONE	nely filed s will be considered timely. the mailing date of this communication. D (35 U.S.C. § 133).					
Status							
1) Responsive to communication(s) filed on 21 December 2004.							
2a) This action is <b>FINAL</b> . 2b) This	action is non-final.						
	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.						
Disposition of Claims							
<ul> <li>4)  Claim(s) 22-26 and 34-50 is/are pending in the 4a) Of the above claim(s) 1-21 and 34-50 is/are 5)  Claim(s) is/are allowed.</li> <li>6)  Claim(s) 22-26 is/are rejected.</li> <li>7)  Claim(s) is/are objected to.</li> <li>8)  Claim(s) are subject to restriction and/or</li> </ul>	e withdrawn from consideration.						
Application Papers							
9) The specification is objected to by the Examine	er.	•					
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.							
Applicant may not request that any objection to the		· ·					
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Ex	• • • • • • • • • • • • • • • • • • • •	•					
Priority under 35 U.S.C. § 119							
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:  1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in Application rity documents have been receive u (PCT Rule 17.2(a)).	on No ed in this National Stage					
Attachment(s)	_						
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	4) Interview Summary Paper No(s)/Mail Da						
<ol> <li>Notice of Draftsperson's Patent Drawing Review (PTO-948)</li> <li>Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)         Paper No(s)/Mail Date     </li> </ol>	. 🗀	atent Application (PTO-152)					

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## **DETAILED ACTION**

#### Election/Restrictions

- 1. Applicant's election of Group II (Claims 22-26 and 34-50) and Species I (drawn to Figs. 1 and 2) in the reply filed on December 21, 2004 is acknowledged. However, upon further review that claims 34-50 are readable on nonelected Species II, which are independent or distinct form the elected Species I, because Claims 34-38 (require two lids) are readable on Species II, Claims 39-41 (have no substrate) are readable on Species III, etc. Further applicant is not entitled to examination of multiple independent inventions in one application. For above reasons Claims 34-50 are withdrawn from consideration as being drawn to nonelected Species II, and the restriction is hereby made final.
- 2. Claims 34-50 are withdrawn from further consideration pursuant to 37 CFR 1.142(b) as being drawn to a nonelected invention, there being no allowable generic or linking claim.

# Claim Rejections - 35 USC § 103

- 3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 4. Claims 22-26 are rejected under 35 U.S.C. 103(a) as being unpatentable over US Patent No. 5,635,754 to Strobel et al in view of US Patent No. 6,303,997 to Lee.

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Regarding claim 22, Strobel et al disclose a method of shielding an integrated circuit device comprising forming package layers each having radiation shielding base (510, 810, etc.), a package (500, 800, etc.) and circuit die (see Strobel 580, 880, etc.; Figs. 4D, 5D, etc.), and a lid (570/870) coupling to a package layer. Lee teaches to couple/stack multiple integrated circuits together to form a thin and semiconductor package having improved electrical and thermal performance. It would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the invention of Strobel by providing an integral stack of at least two or more package layers together as taught by Lee as to form a desired semiconductor package and improving electrical and heat dissipating performance of the integrated circuit would result (see Lee Col. 1, line 6-13 or Col. 2, lines 35-45).

Regarding claims 23 and 24, noting Strobel et al disclose the lid and radiation shielding bases are formed from a high Z material (Fig. 4D).

Regarding claims 25 and 26, noting Strobel et al disclose circuit dies receive an amount of radiation less than the total dose tolerance of the second circuit die (Col. 7, lines 62-67).

5. In alternative, Claims 22 is rejected under 35 U.S.C. 103(a) as being unpatentable over Lee in view of Strobel et al.

Lee discloses a method of shielding an integrated circuit device comprising: forming a first package layer (100) comprising a first base (60), a first package (20 and 50) and a first circuit die (10); forming a second package layer comprising a second base (60), a second package (60) and a second circuit die (10); coupling a bottom of the first package layer to a top of the second package layer (See Fig. 3). Lee does not disclose the base is radiation shield and

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the step of coupling a lid to the first package layer. Strobel et al teach the radiation shield base (510/810) and coupling a lid (570/870) to the first package layer (500/800 see Strobel Figs. 4D and 5D) for withstanding the thermal and radiation hazards (see Strobel Col. 3, line 65 to Col. 4, line 21). It would have been obvious to one having ordinary skill in the art at the time the invention was made to utilize the teaching of Strobel et al including base of radiation shield and the lid onto the invention of Lee in order to form a desired base structure for preventing radiation penetrating through the integrated circuit device.

## Conclusion

- 6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. The prior art references cited for the teachings of radiation shielding an integrated circuit.
- 7. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Donghai D. Nguyen whose telephone number is (571)-272-4566. The examiner can normally be reached on Monday-Friday (9:00-6:00).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Peter D. Vo can be reached on (571)-272-4690. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

DN February 2, 2005 MINHTRINH
PRIMARY EXAMINER

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